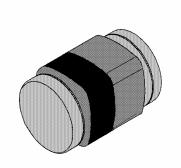
SILICON EPITAXIAL PLANAR DIODES

LS-31

Features

- · Saving space
- Hermetic sealed parts
- Fits onto SOD 323 / SOT 23 footprints
- Electrical data identical with the device 1N4148
- Micro Melf package



Applications

Extreme fast switches

Absolute Maximum Ratings (T_a = 25°C)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V _{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	75	V
RMS Reverse Voltage		$V_{R(RMS)}$	53	V
Forward Continuous Current (Note 1)	MCL914 MCL914A / B	I _{FM}	150 300	mA
Average Rectified Output Current (Note 1)	MCL914 MCL914A / B	Io	75 200	mA
Non-Repetitive Peak Forward Surge Current MCL914 MCL914A / B	@ t = 1s @ t = 1us @t = 1us	I _{FSM}	1 1 4	А
Power Dissipation (Note 1) Derate Above 25°C		P _d	500 1.68	mW mW/°C
Thermal Resistance, Junction to Ambient Air (Note 1)		$R_{ heta JA}$	300	K/W
Operating and Storage Temperature Range		T _j ,T _S	-65 to +175	°C









MCL914, MCL914A, MCL914B

Characteristics at T_i = 25°C

Characteristic		Symbol	Min.	Max.	Unit
Forward Voltage					
at I _F = 5mA	1N914B		0.62	0.72	
at I _F = 100mA	1N914B	V_{F}	-	1	V
at I _F = 10mA	1N914		-	1	
at I _F = 20mA	1N914A		-	1	
Peak Reverse Current					
at $V_R = 75V$			-	5	uA
at $V_R = 20V$, $T_A = 150^{\circ}C$		I _R	-	50	uA
at $V_R = 20V$			-	25	nA
Diode Capacitance		C		4	25
at $V_R = 0$, $f = 1MHz$		C _o	-	4	pF
Reverse Recovery Time at I_F = 10mA to I_R = 1mA, V_R = 6V, R_L = 100 Ω		т		4	nS
		T _{RR}	-	4	110

Note 1: Valid provided that lead are kept at ambient temperature at a distance of 8 mm.

Dimensions in mm Cathode indification 1.35 max. Glass Ø1.25 -0.05 R≥2.5 Glass 0.21+0.05 2.0+/-0.1 Glass case technical drawings Micro MELF according to DIN specifications



SEMTECH ELECTRONICS LTD.







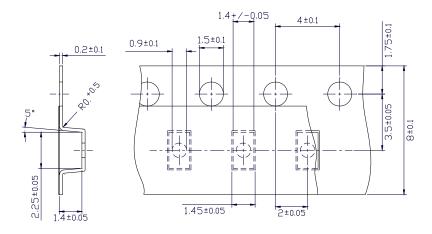


MCL914, MCL914A, MCL914B

Technical Information

Taping of SMD-Components

We supplies the SMD components either in bulk or in 8-mm or 12-mm blister tapes depending on type of case. Both the tape dimensions for the cases MicroMELF and dimensions of the reels are shown in the following figures.



Accumulated pitch tolerance is ± 0.2 mm over 10 pitches

8-mm carrier tape for MicroMELF package dimensions in mm

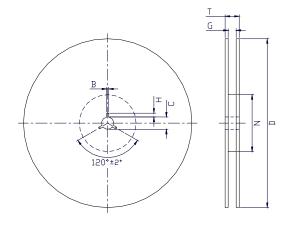








Technical Information



The beginning of the tape comprises a 200 mm long lead-in with vacant nests and at the hub end of the tape there are 10 to 20 sealed nests containing no devices . This end of the tape automatically detaches from the hub of the reel at the end of the in reeling procedure (Draft DIN IEC 49(CO)564).

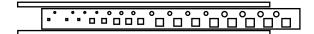
The packaging units for taped devices are

Type of case	Qty / reel	Reel Ø
MicroMELF	2,500	178mm

	8-mm	12-mm
	carrier tape	carrier tape
В	2±0.5	2±0.5
С	13±0.5	13±0.5
D	178±2	330±2
G	8.4±1.5	12.4±2
Н	4±0.5	4±0.5
N	60	60
Т	<14.9	<20

Dimensions in mm

Pull-out direction



Reel for 8-mm and 12-mm carrier tapes

The carrier tape consists of a plastic tape with "nests" having a size corresponding to the components requirements. The sprocket holes are on one side of the tape. The blister tapes are sealed with a cover tape.

The cathode side of the components MicroMELF cases are adjacent to the sprocket holes. Other orientation can be supplied on demand.













Dated: 20/08/2002